



ALPHA & OMEGA
SEMICONDUCTOR

AON4803

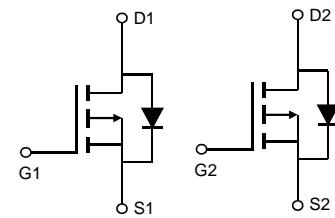
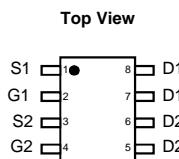
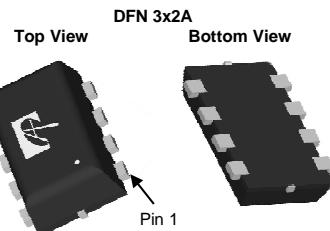
20V Dual P-Channel MOSFET

General Description

The AON4803 combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. This device is ideal for load switch and battery protection applications.

Product Summary

| | |
|-----------------------------------|---------|
| V_{DS} | -20V |
| I_D (at $V_{GS}=-4.5V$) | -3.4A |
| $R_{DS(ON)}$ (at $V_{GS}=-4.5V$) | < 90mΩ |
| $R_{DS(ON)}$ (at $V_{GS}=-2.5V$) | < 120mΩ |
| $R_{DS(ON)}$ (at $V_{GS}=-1.8V$) | < 165mΩ |



Absolute Maximum Ratings $T_A=25^\circ\text{C}$ unless otherwise noted

| Parameter | Symbol | Maximum | Units |
|--|----------------|------------|-------|
| Drain-Source Voltage | V_{DS} | -20 | V |
| Gate-Source Voltage | V_{GS} | ± 8 | V |
| Continuous Drain Current <small>$T_A=25^\circ\text{C}$</small> | I_D | -3.4 | A |
| | | -2.7 | |
| Pulsed Drain Current ^C | I_{DM} | -15 | W |
| Power Dissipation ^B <small>$T_A=25^\circ\text{C}$</small> | P_D | 1.7 | |
| | | 1.1 | |
| Junction and Storage Temperature Range | T_J, T_{STG} | -55 to 150 | °C |

Thermal Characteristics

| Parameter | Symbol | Typ | Max | Units |
|---|-----------------|-----|-----|-------|
| Maximum Junction-to-Ambient ^A <small>$t \leq 10\text{s}$</small> | $R_{\theta JA}$ | 51 | 75 | °C/W |
| Maximum Junction-to-Ambient ^{A,D} <small>Steady-State</small> | | 88 | 110 | °C/W |
| Maximum Junction-to-Lead | $R_{\theta JL}$ | 28 | 35 | °C/W |

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
|-----------------------------|---------------------------------------|--|------|-------|-----------|------------------|
| STATIC PARAMETERS | | | | | | |
| BV_{DSS} | Drain-Source Breakdown Voltage | $I_D=-250\mu\text{A}$, $V_{GS}=0\text{V}$ | -20 | | | V |
| I_{DSS} | Zero Gate Voltage Drain Current | $V_{DS}=-20\text{V}$, $V_{GS}=0\text{V}$ $T_J=55^\circ\text{C}$ | | | -1 | μA |
| I_{GSS} | Gate-Body leakage current | $V_{DS}=0\text{V}$, $V_{GS}=\pm 8\text{V}$ | | | ± 100 | nA |
| $V_{\text{GS(th)}}$ | Gate Threshold Voltage | $V_{DS}=V_{GS}$ $I_D=-250\mu\text{A}$ | -0.4 | -0.65 | -1 | V |
| $I_{\text{D(ON)}}$ | On state drain current | $V_{GS}=-10\text{V}$, $V_{DS}=-5\text{V}$ | -15 | | | A |
| $R_{\text{DS(ON)}}$ | Static Drain-Source On-Resistance | $V_{GS}=-4.5\text{V}$, $I_D=-3.4\text{A}$ | | 65 | 90 | $\text{m}\Omega$ |
| | | $T_J=125^\circ\text{C}$ | | 90 | 125 | |
| | | $V_{GS}=-2.5\text{V}$, $I_D=-2.5\text{A}$ | | 80 | 120 | |
| g_{FS} | Forward Transconductance | $V_{GS}=-1.8\text{V}$, $I_D=-1.5\text{A}$ | | 100 | 165 | $\text{m}\Omega$ |
| | | $V_{DS}=-5\text{V}$, $I_D=-3.4\text{A}$ | | | 12 | |
| | | $I_S=-1\text{A}$, $V_{GS}=0\text{V}$ | | | -0.7 | -1 |
| I_s | Maximum Body-Diode Continuous Current | | | | -2 | A |
| DYNAMIC PARAMETERS | | | | | | |
| C_{iss} | Input Capacitance | $V_{GS}=0\text{V}$, $V_{DS}=-10\text{V}$, $f=1\text{MHz}$ | | 560 | 745 | pF |
| C_{oss} | Output Capacitance | | | 80 | | pF |
| C_{rss} | Reverse Transfer Capacitance | | | 70 | | pF |
| R_g | Gate resistance | $V_{GS}=0\text{V}$, $V_{DS}=0\text{V}$, $f=1\text{MHz}$ | | 15 | 23 | Ω |
| SWITCHING PARAMETERS | | | | | | |
| Q_g | Total Gate Charge | $V_{GS}=-4.5\text{V}$, $V_{DS}=-10\text{V}$, $I_D=-3.4\text{A}$ | | 6.1 | 8 | nC |
| Q_{gs} | Gate Source Charge | | | 0.6 | | nC |
| Q_{gd} | Gate Drain Charge | | | 1.6 | | nC |
| $t_{\text{D(on)}}$ | Turn-On Delay Time | $V_{GS}=-4.5\text{V}$, $V_{DS}=-10\text{V}$, $R_L=2.9\Omega$, $R_{\text{GEN}}=3\Omega$ | | 10 | | ns |
| t_r | Turn-On Rise Time | | | 12 | | ns |
| $t_{\text{D(off)}}$ | Turn-Off Delay Time | | | 44 | | ns |
| t_f | Turn-Off Fall Time | | | 22 | | ns |
| t_{rr} | Body Diode Reverse Recovery Time | $I_F=-3.4\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$ | | 21 | | ns |
| Q_{rr} | Body Diode Reverse Recovery Charge | $I_F=-3.4\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$ | | 7.5 | | nC |

A. The value of R_{QJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with $T_A=25^\circ\text{C}$. The value in any given application depends on the user's specific board design.

B. The power dissipation P_D is based on $T_{J(\text{MAX})}=150^\circ\text{C}$, using $\leqslant 10\text{s}$ junction-to-ambient thermal resistance.

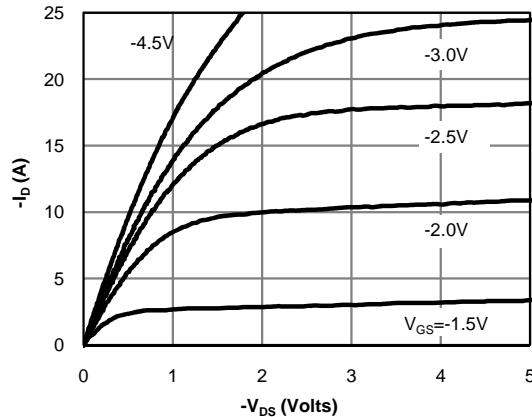
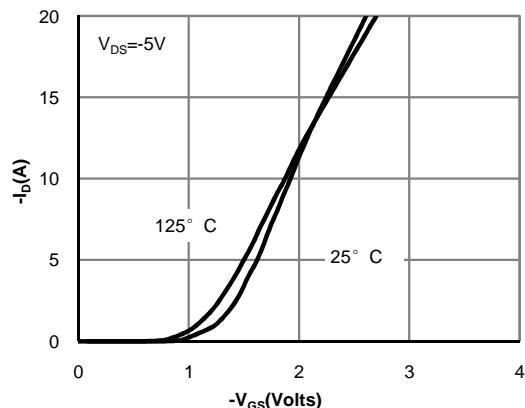
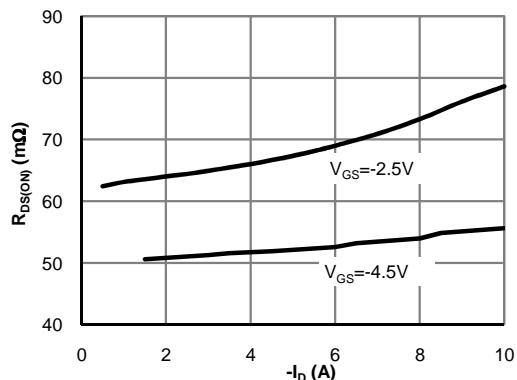
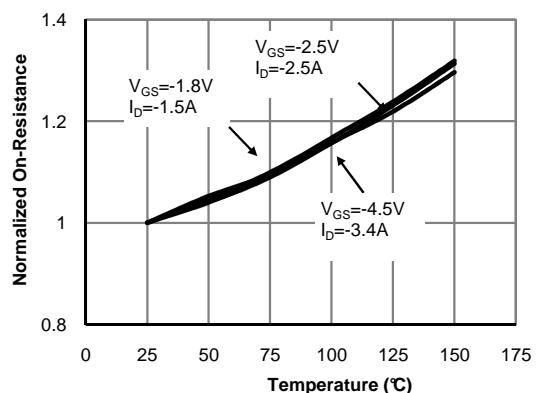
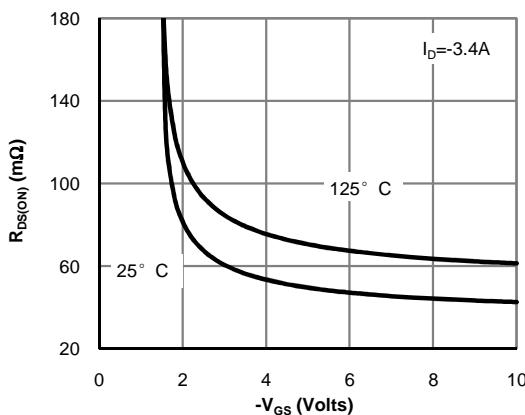
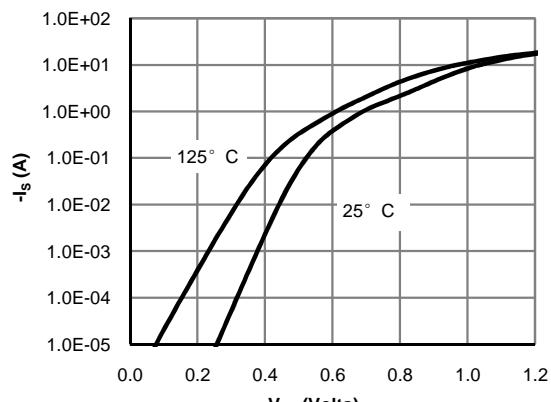
C. Repetitive rating, pulse width limited by junction temperature $T_{J(\text{MAX})}=150^\circ\text{C}$. Ratings are based on low frequency and duty cycles to keep initial $T_J=25^\circ\text{C}$.

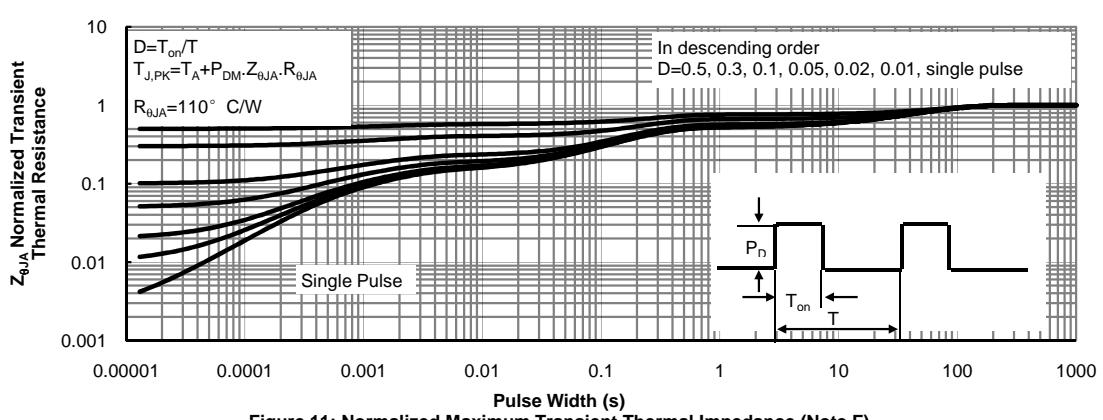
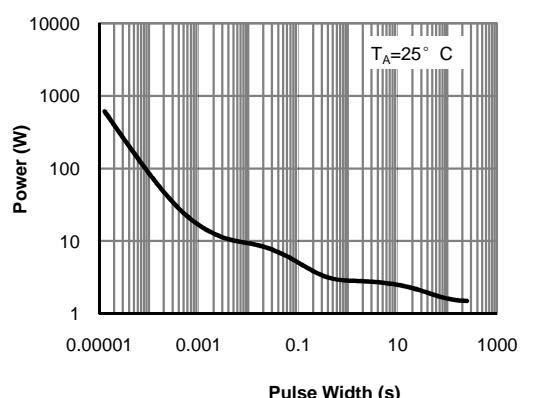
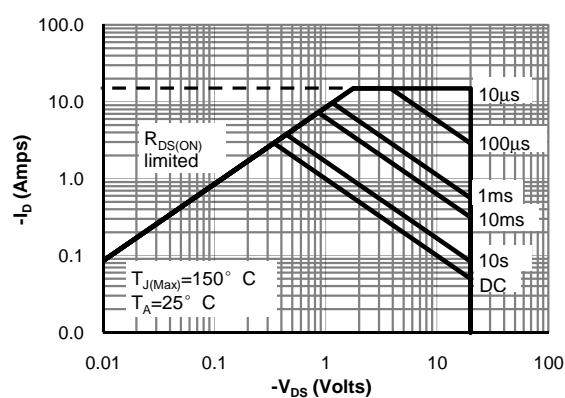
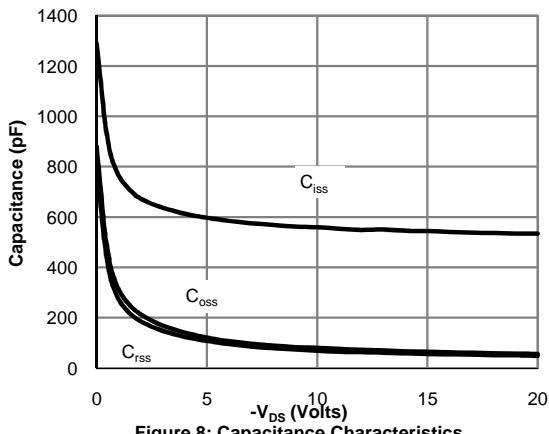
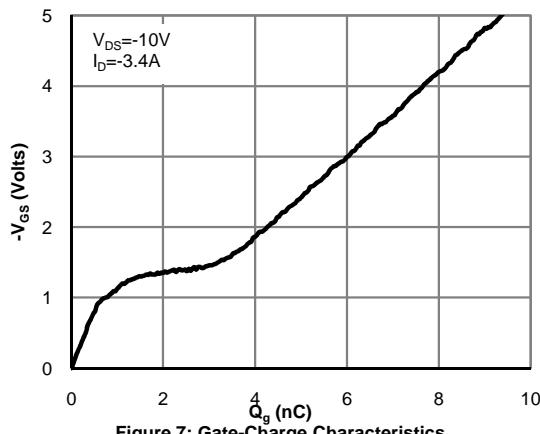
D. The R_{QJA} is the sum of the thermal impedance from junction to lead R_{QJL} and lead to ambient.

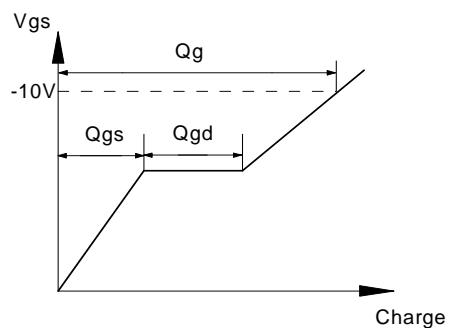
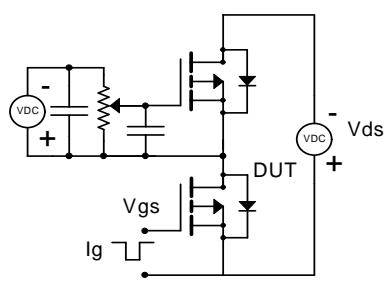
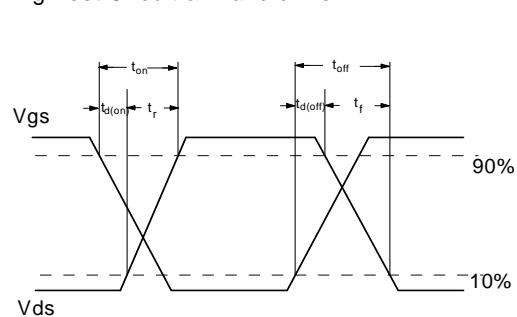
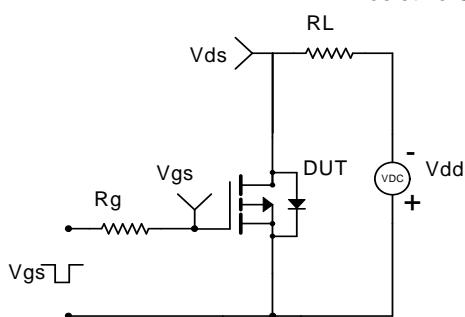
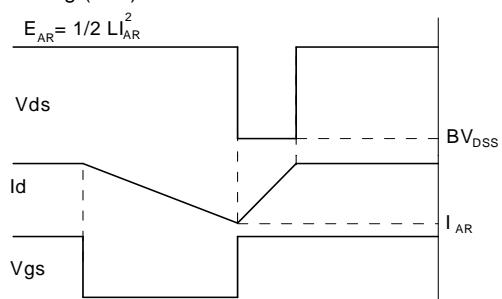
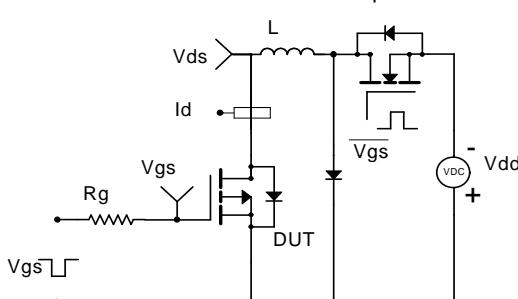
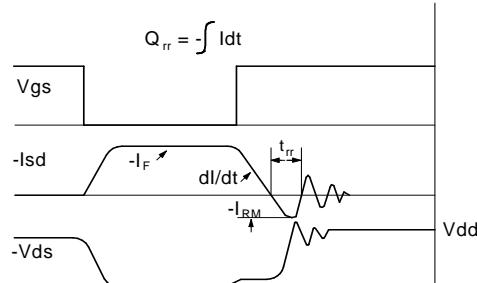
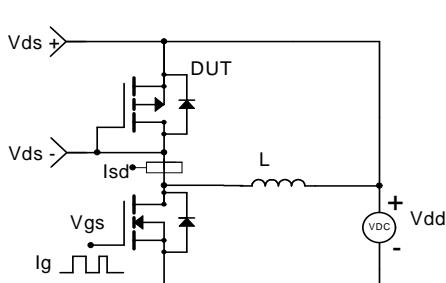
E. The static characteristics in Figures 1 to 6 are obtained using $<300\mu\text{s}$ pulses, duty cycle 0.5% max.

F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, assuming a maximum junction temperature of $T_{J(\text{MAX})}=150^\circ\text{C}$. The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Fig 1: On-Region Characteristics (Note E)

Figure 2: Transfer Characteristics (Note E)

Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

Figure 4: On-Resistance vs. Junction Temperature (Note E)

Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Gate Charge Test Circuit & Waveform

Resistive Switching Test Circuit & Waveforms

Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

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